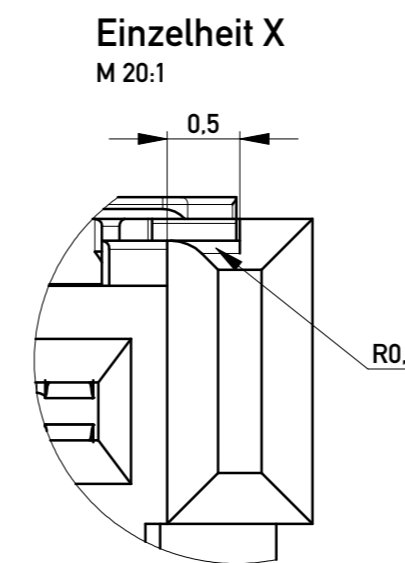
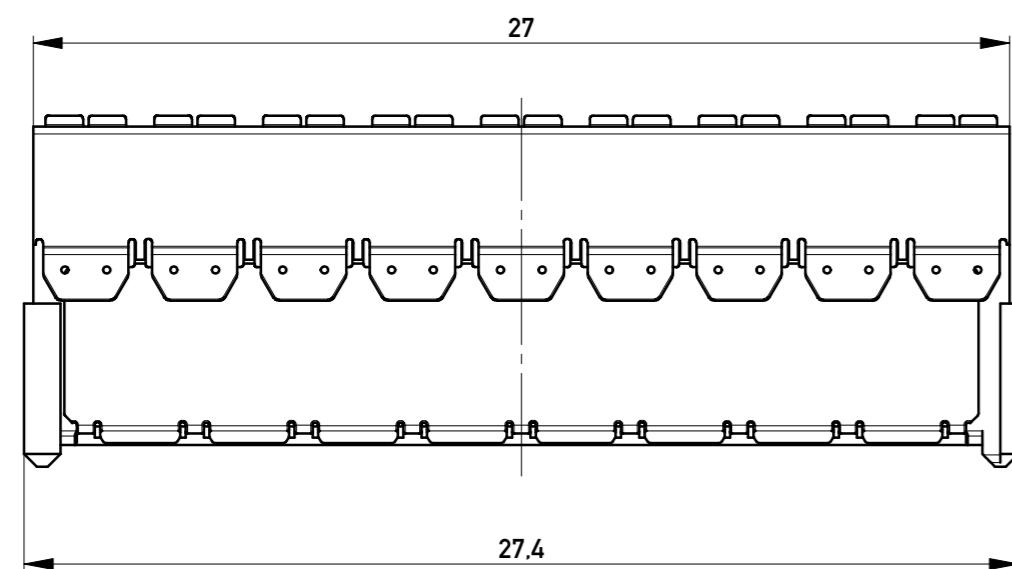
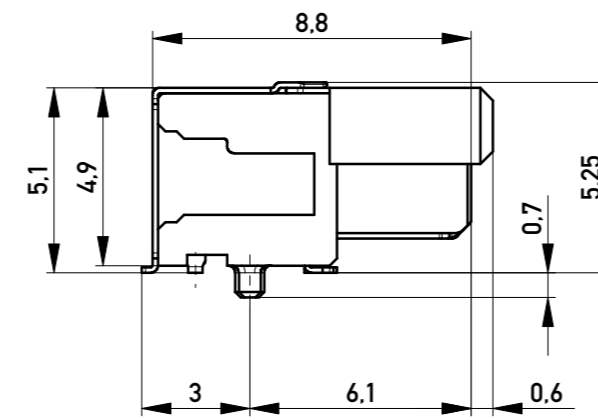
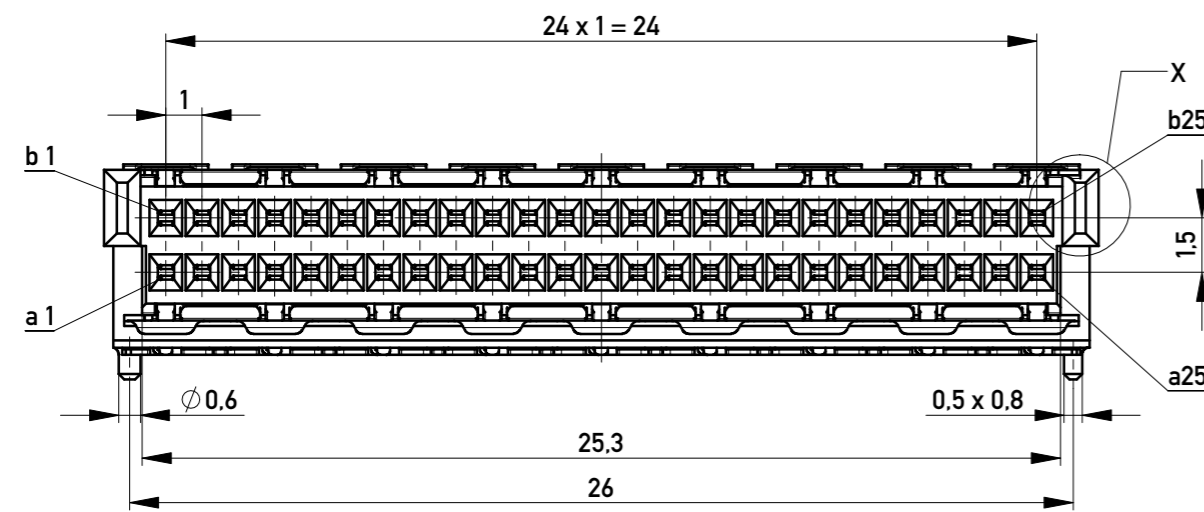
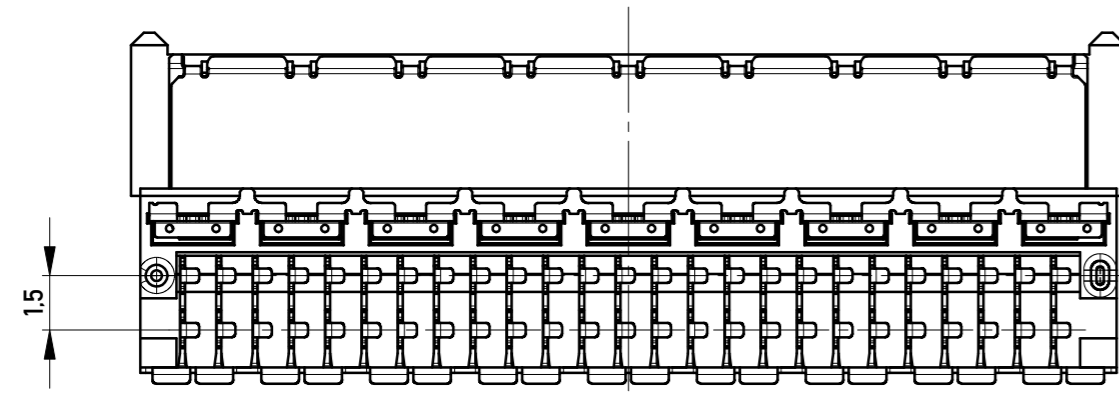
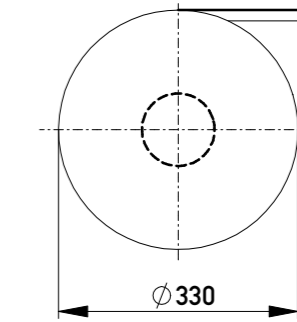
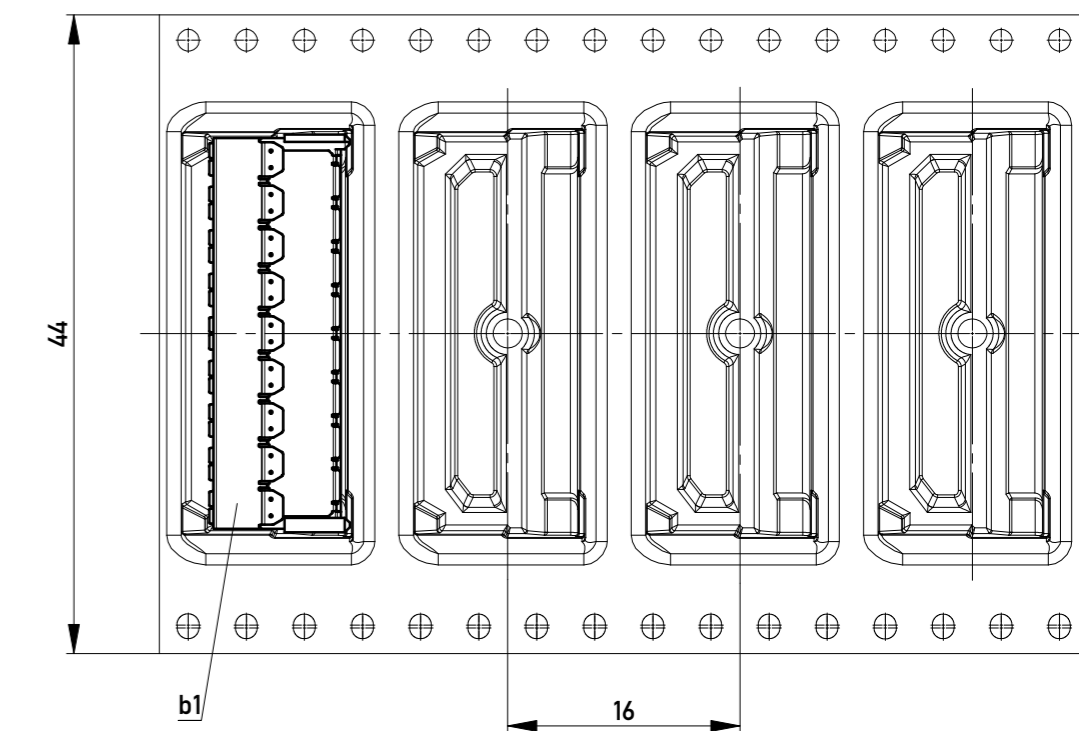


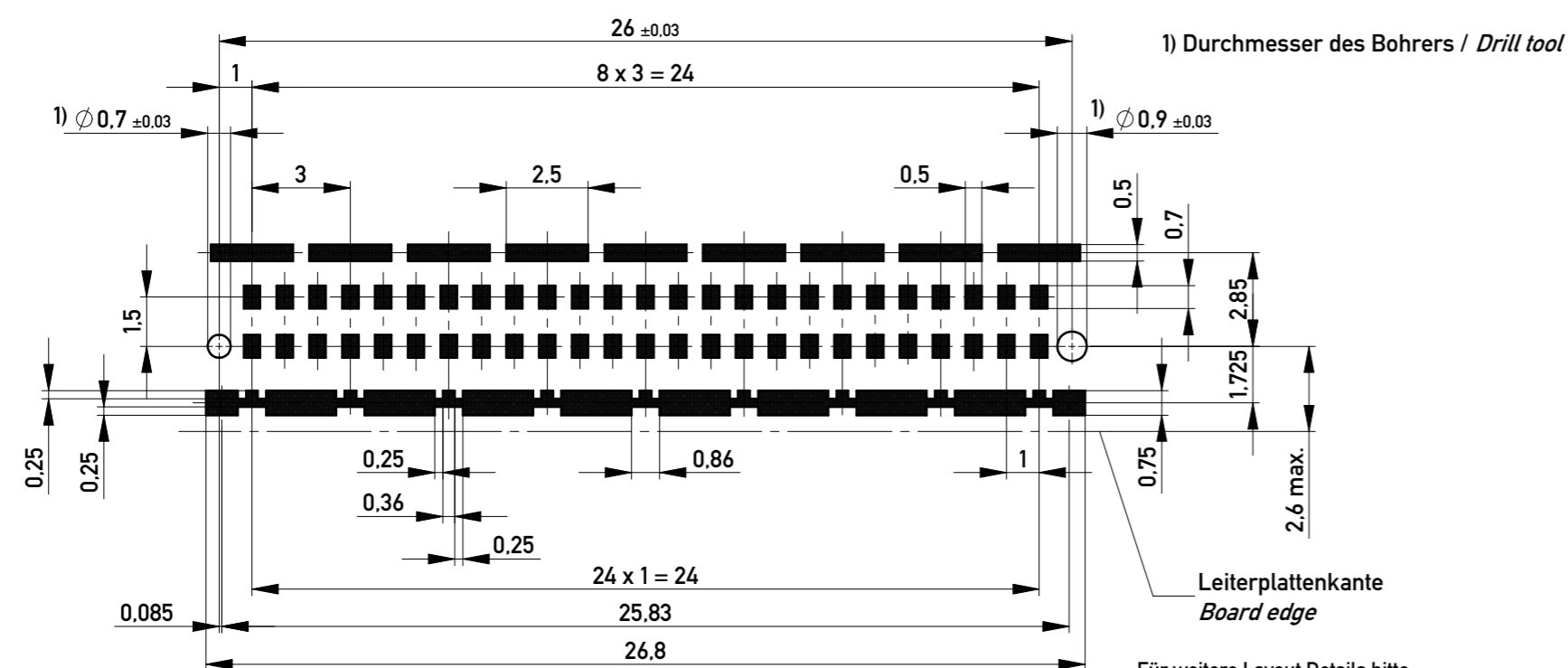
Verpackt im Gurt in Anlehnung an DIN IEC 60286-3
 Tape on Reel Packaging according to DIN IEC 60286-3
 Verpackungseinheit: 500 Stück
 Packaging unit: 500 pcs



Abspulrichtung - Reel off Direction



Leiterplatten-Layout Vorschlag / PCB-Layout Proposal



Leiterplattenkante
Board edge

Für weitere Layout Details bitte
 Applikations Schrift MicroSpeed beachten.
 For further layout details please consider
 MicroSpeed application note.

Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Information:	Tolerances	Scale 5:1	
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			Federl. 90° 50p. BM SMD EMV Female 90° 50 c. BM SMD EMV
h	06.09.2016	www.ERNI.com	284310
Index	Date	Class	MSPEED

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